# PLA HOTOSO

its full term is Poly-Lactic Acid and it is a thermoplastic polymer. Because it is derived from natural sources like corn and sometimes sugarcane, PLA is sometimes referred to a bioplastic. The majority of other thermoplastics are distilled from non-renewable resources like petroleum.

In addition, because it is a natural product, it is also long-term biodegradable. This means that when discarded into a compost ing system, PLA will naturally break down into its constituent parts typically within a few years.

**Pros** 

Can be printed on a cold surface more environmental-friendly shinier and smoother appearance More detail

Cons

Can deform because of heat Less sturdy

Uses

Consumer products

### 1. Identification of the material

Trade name HotOrange3D PLA

Chemical name Poly-Lactic Acid

Use 3D printing

Origin HotOrange3D Netherlands

## 2. Material properties

Melt temperature	145-160	°C	ASTM D3418
Glass transition temperature	55-60	°C	ASTM D3419
Heat distortion temperature HDTB (0,45 MPa)	56	°C	ISO 75
Vicat Softening Temperature	60	°C	ASTM D1525
Met Flow Rate (210 C/2.16 kg)	9,56	g	ASTM D1238
Density	1.24	g/cm <sup>3</sup>	ASTM D790
Water absorption, 24 u	0.1	%	ASTM D570
Shrink rate	0.5 - 0.7	%	ASTM D955



### 3. Mechanical properties

Tensile Strength (break, 3.20 mm/50 mm/min)	52	MPa	ISO 527
Tensile Modulus (3.20 mm/1.0 mm/min)	1320	MPa	ISO 527
Tensile elongation, (break, 3.20 mm/50 mm/min)	5	%	ISO 527
Flexural Modulus (3.20 mm/15 mm/min)	3600	MPa	ISO 178
Flexural Strength (3.20 mm/15 mm/min)	108	MPa	ISO 178
Rockwell hardness (R-scale)	95		ASTM D785

# 4. Printer settings

Printer	Desktop FFF printer
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Nozzle 0.4 mm A2 hardened

Layer height 0.2 mm

Infill 100% ±45

Extrusion Temperature 190 - 220 °C

Bed temperature 46 - 60 °C

Bed preparation Kapton tape, Glass, 3D laque

Print speed 20-40 mm/sec

Requirements Cooling fan

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